

60V N-Channel Enhancement Mode MOSFET

Description

The CP80N06G uses advanced trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

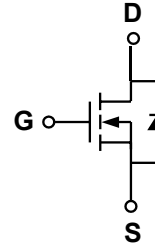
General Features

- ◆ $V_{DS} = 60V$, $I_D = 80A$
 $R_{DS(ON)}(Typ.) = 6m\Omega$ @ $V_{GS} = 10V$
 $R_{DS(ON)}(Typ.) = 9.8m\Omega$ @ $V_{GS} = 6V$
- ◆ Excellent gate charge x $R_{DS(on)}$ product(FOM)
- ◆ Very low on-resistance $R_{DS(on)}$
- ◆ 150 °C operating temperature
- ◆ 100% UIS tested

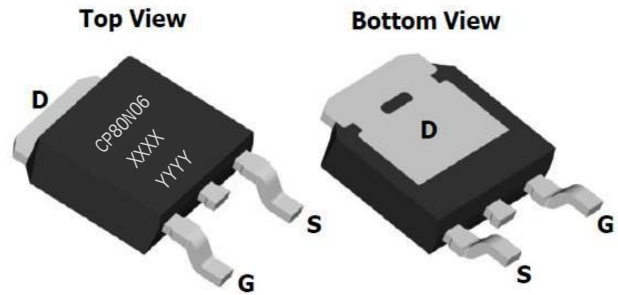
Application

- ◆ Synchronous Rectification in DC/DC and AC/DC Converters
- ◆ Industrial and Motor Drive applications

Schematic diagram



Marking and pin assignment



XXXX—Wafer Information YYYY—
Quality Code

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
CP80N06G-G	-55°C to +150°C	TO-252-2L	2500

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter		symbol	limit	unit
Drain-source voltage		V_{DS}	60	V
Gate-source voltage		V_{GS}	±20	V
Continuous Drain Current	TC=25°C	I_D	80	A
	TC=70°C		63	
Pulsed Drain Current		I_{DP}	145	A
Avalanche energy($T_J=25^\circ C$, $V_{DD}=30V$, $V_G=10V$, $L=0.5mH$, $R_g=25\Omega$)		E_{AS}	100	mJ
Power Dissipation	TC=25°C	P_D	83	W
	TC=70°C		53	
Operating junction Temperature range		T_J	-55—150	°C

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	60	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =60V, V _{GS} =0V	-	-	1	μA
		T _J =85°C	-	-	5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2	2.7	4	V
Drain-source on-state resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	6	7.6	mΩ
		V _{GS} =6V, I _D =20A	-	9.8	10.5	
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =20A	-	140	-	S
Diode Characteristics						
Diode Forward Voltage	V _{SD}	I _{SD} =20A, V _{GS} =0V	-	0.82	1.2	V
Diode Continuous Forward Current	I _S		-	-	80	A
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S di/dt = 100A/μs	-	33	-	ns
Reverse Recovery Charge	Q _{rr}		-	125	-	nC
Dynamic Characteristics						
Gate Resistance	R _G	V _{GS} =0V, V _{DS} =0V, f=1MHz	-	0.5	1.8	Ω
Input capacitance	C _{ISS}	V _{GS} =0V, V _{DS} =30V f=1.0MHz	-	3774	-	pF
Output capacitance	C _{OSS}		-	266	-	
Reverse transfer capacitance	C _{RSS}		-	229	-	
Turn-on delay time	t _{D(ON)}	V _{GS} =10V, V _{DS} =30V, R _L =1.5Ω, R _G =3Ω	-	13	-	ns
Turn-on Rise time	tr		-	14	-	
Turn-off delay time	t _{D(OFF)}		-	47	-	
Turn-off Fall time	t _f		-	6.5	-	
Total gate charge	Q _g	V _{GS} =10V, V _{DS} =30V, I _D =20A	-	74.3	-	nC
Gate-source charge	Q _{gs}		-	17.1	-	
Gate-drain charge	Q _{gd}		-	22.9	-	

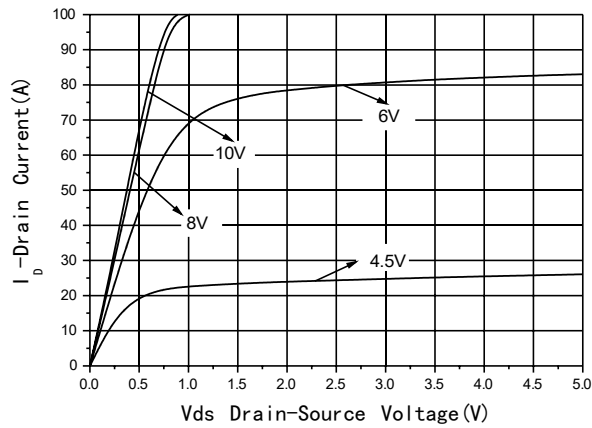
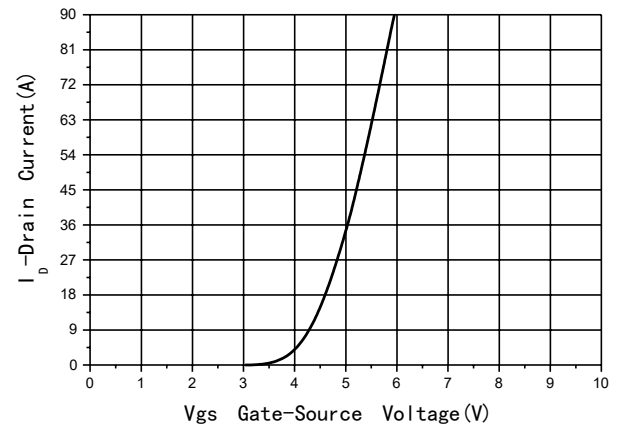
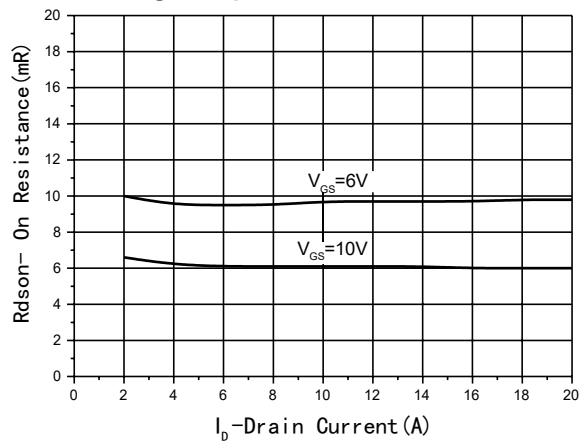
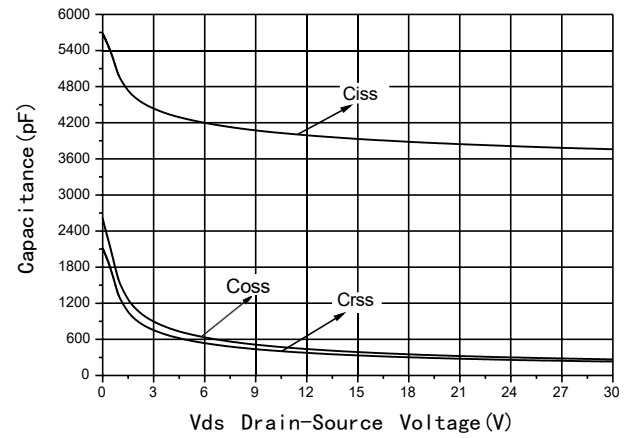
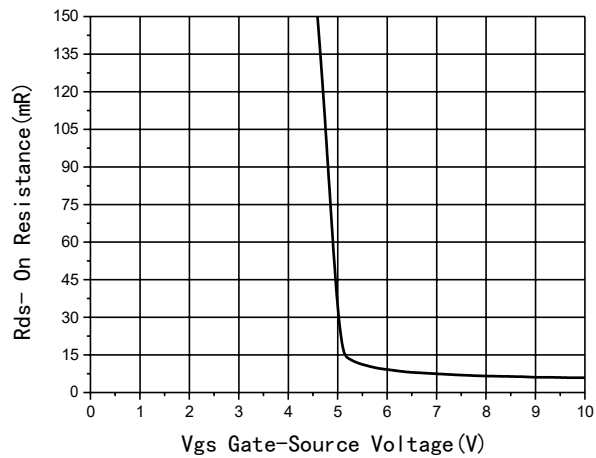
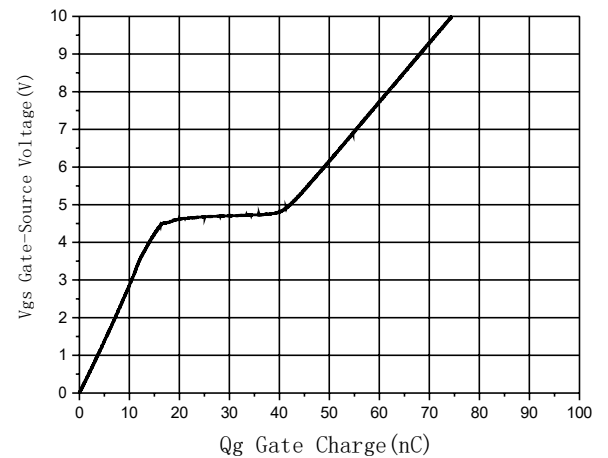
Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Maximum Junction-to-Ambient ^A	R _{θJA}	20	25	°C/W
Maximum Junction-to-Ambient ^A		45	55	
Maximum Junction-to-Lead ^B	R _{θJC}	1	1.5	

A: The value of R_{θJA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

Typical Performance Characteristics


Fig1 Output Characteristics

Fig2 Transfer Characteristics

Fig3 $R_{DS(on)}$ -Drain current

Fig4 Capacitance vs V_{DS}

Fig5 $R_{DS(on)}$ -Gate Drain voltage

Fig6 Gate Charge

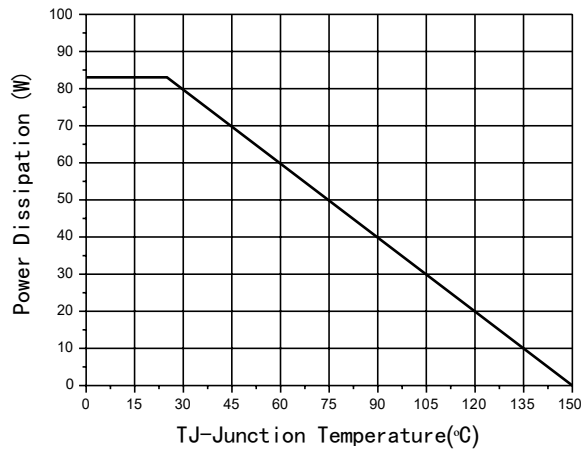


Fig7 Power De-rating

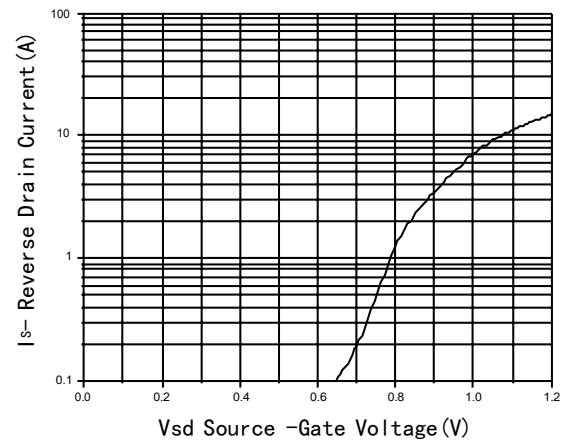
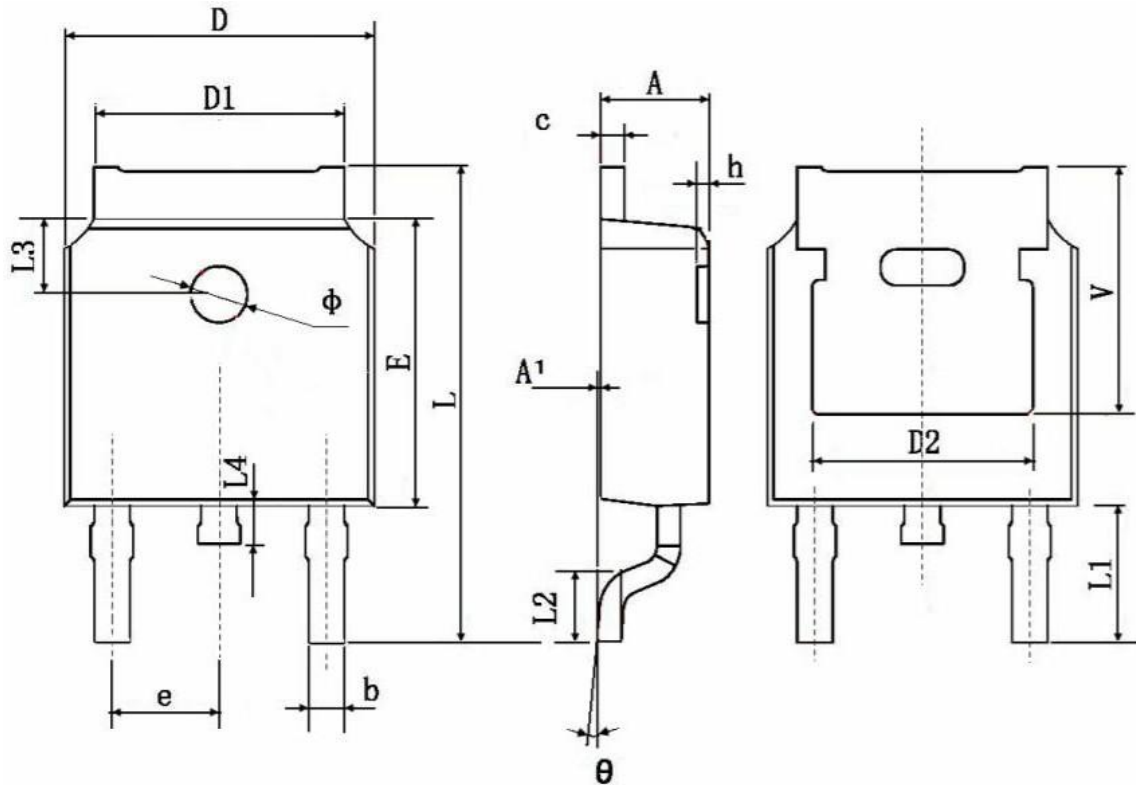


Fig8 Source-Drain Diode Forward

Package Information

- TO-252-2L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	